

ZXCT1021 Low offset high-side current monitor

Description

The ZXCT1021 is a precision high-side current sense monitor. Using this type of device eliminates the need to disrupt the ground plane when sensing a load current.

The ZXCT1021 provides a fixed gain of 10 for applications where minimal sense voltage is required.

The very low offset voltage enables a typical accuracy of 3% for sense voltages of only 10mV,

Features

- Accurate high-side current sensing
- Output voltage scaling
- 2.5V 20V supply range
- 25µA quiescent current
- 1% typical accuracy
- SOT23-5 package

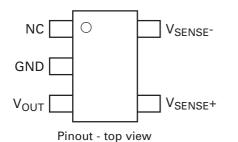
giving better tolerances for small sense resistors necessary at higher currents.

The wide input voltage range of 20V down to as low as 2.5V make it suitable for a range of applications. With a minimum operating current of just 25μ A, combined with its SOT23-5 package make it suitable for portable battery equipment too.

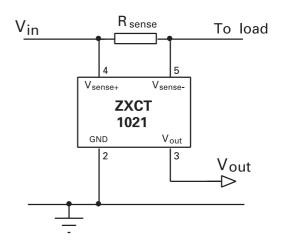
Applications

- Battery chargers
- Smart battery packs
- DC motor control
- Over current monitor
- Power management
- Level translating
- Programmable current source

Pinout information



Typical application circuit



Ordering information

Order reference	Package	Device marking	Status	Reel size (inches)	Quantity per reel	Tape width (mm)
ZXCT1021E5TA	SOT23-5	1021	Released	7	3000	8

Absolute maximum ratings

Voltage on any pin with respect to END pin	-0.6V to 20V
V _{SENSE}	-0.6V to V _{IN} +0.5V
Operating temperature	-40 to 85°C
Storage temperature	-55 to 150°C
Package power dissipation	$(T_{amb} = 25^{\circ}C)$
SOT23-5	300mW

Pinout information

Pin name	Pin function
N/C	Not internally connected
GND	Ground
V _{OUT}	Voltage output referenced to GND. Intended to drive high impedance loads
V _{SENSE-}	High impedance negative sense voltage input
V _{SENSE+}	Supply and positive sense voltage input

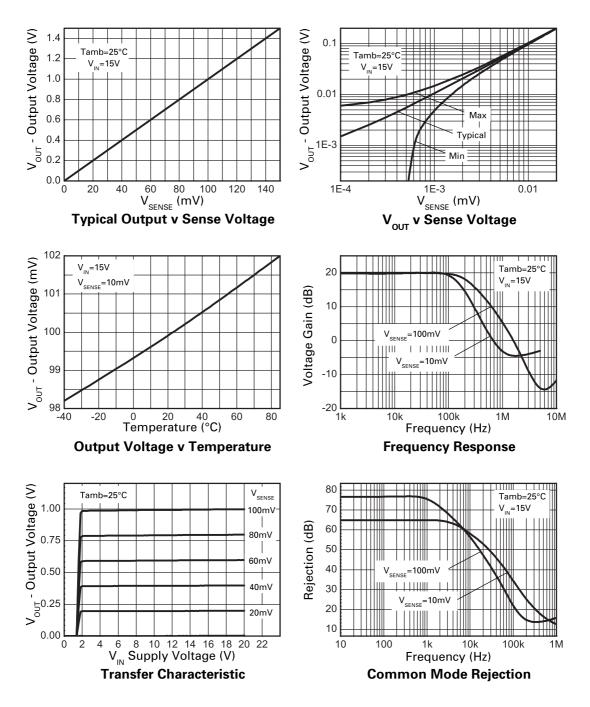
Symbol	Parameter	Conditions	Limits			Unit
			Min.	Тур.	Max.	
V _{IN}	V _{CC} range		2.5		20	V
V _{OUT}	Output voltage	V _{SENSE} = 30mV	291	300	309	mV
		V _{SENSE} = 100mV	0.98	1.00	1.02	V
		V _{SENSE} = 150mV	1.47	1.50	1.53	V
R _{OUT}	Output resistance		10	15	20	kΩ
T _C ^(*)	Output voltage temperature coefficient			50	300	ppm
١ ₀	Ground pin current	V _{SENSE} = 0V		25	35	μA
V _{SENSE} (†)	Sense voltage	V _{IN} = 20V	0		1.5 ^(‡)	V
I _{LOAD}	V _{SENSE-} load pin input current	V _{SENSE} = 0V			100	nA
Acc	Accuracy	V _{SENSE} = 100mV	-2		2	%
Gain	V _{OUT} / V _{SENSE}	V _{SENSE} = 100mV	9.8	10	10.2	V/V
BW	Bandwidth	V _{SENSE} = 10mV		300		kHz
		V _{SENSE} = 100mV		2		MHz

Electrical characteristics test conditions T_{amb} = 25°C, V_{IN} = 15V

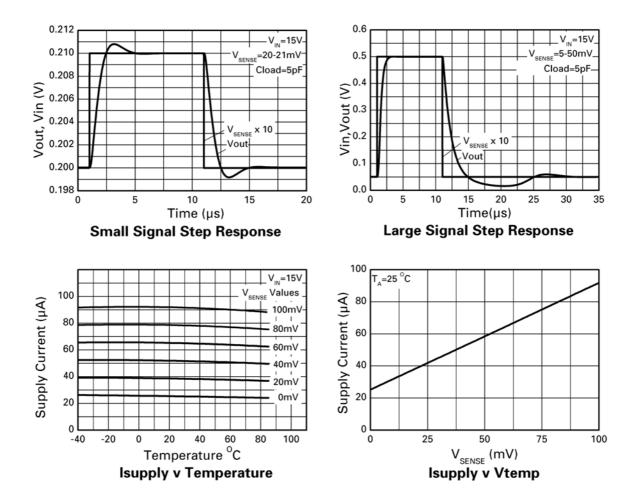
NOTES:

(*) T_{C} limits are determined by characterization (†) $V_{SENSE} = V_{IN} - V_{LOAD}$ (‡) This will be reduced at lower V_{IN} voltages due to clipping of output voltage.

Typical characteristics



Typical characteristics



Application information

The ZXCT1021 has a fixed dc voltage gain of 100. No external scaling resistors are required for the output. Output voltage is simply defined as:

$V_{OUT} = 10 \times V_{SENSE} (V)$

Where $V_{SENSE} = V_{IN} - V_{LOAD}$

PCB trace shunt resistor for low cost solution

Figure 1 shows a PCB layout suggestion for a low cost solution where a PCB resistive trace in replacement for a conventional shunt resistor, can be used. The resistor section is 25mm x 0.25mm giving approximately 150m Ω using 1 oz copper. Smaller resistances can be used if required.

Total circuit solution: 1 component. Shows area of $150m\Omega$ sense resistor compared to SOT23 package.

Practical tolerance of the PCB resistor will be around 5% depending on manufacturing methods.

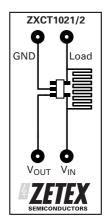
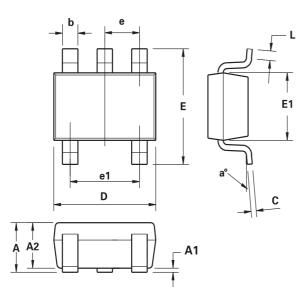


Figure 1 PCB layout suggestion

Package outline - SOT23-5



DIM	Millimeters		Inches		
	Min.	Max.	Min.	Max.	
A	0.90	1.45	0.0354	0.0570	
A1	0.00	0.15	0.00	0.0059	
A2	0.90	1.30	0.0354	0.0511	
b	0.20	0.50	0.0078	0.0196	
C	0.09	0.26	0.0035	0.0102	
D	2.70	3.10	0.1062	0.1220	
E	2.20	3.20	0.0866	0.1181	
E1	1.30	1.80	0.0511	0.0708	
е	0.95	REF	0.037	4 REF	
e1	1.90 REF		0.0748 REF		
L	0.10	0.60	0.0039	0.0236	
a°	0°	30°	0°	30°	

Note: Controlling dimensions are in millimeters. Approximate dimensions are provided in inches

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Issue 9 - July 2007

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